

Compliance Certification Services Certification Division 47173 Benicia Street Fremont, CA 94538, USA

Modular Approval Attestation for Remote Control Module.

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Applicant: LG Innotek Co., Ltd.		
FCC ID: YZP-TWFML303D		

No. F	C requirements	
1	Have its own RF shielding	RF Block shielded by Metal Case
2	Have buffered modulation/data inputs (if such inputs are provided),	Yes, the module has buffered data input.
3	The modular transmitter must have its own power supply regulation.	We used self own power supply regulation.
4	Meet the antenna requirements of section 15.203	This module uses PIFA antenna This module meets the antenn a requ irements o f section 15.203
5	Be tested in a stan d-alone configuration, i.e., the antenna, AC or DC power and data input/output lines must be connected to the module but, the module must not be inside another case during testing	Yes, the EUT (module) was tested a stand alone configuration.
6	Be labeled with its own FCC ID number, and if the FCC ID is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module.	The proposed FCC ID label format is to be placed on the m odule. If FCC ID label is n ot v isible wh en module is install into the system, "Contains FCC ID: YZP-TWFML303D " shall be placed on the outside of final product.
7	The modular transmitter is manufactured so that the user can not influence the operation of the transmitter that will o perate ou tside of the scope o f the regulations.	It com plies with specific ru les o r o perating requirements. And instruction is included User manual.
8	Address compliance with the Com mission's RF exposure limits in Sections 1.1310 and 2.1093. In add ition, spread sp ectrum transmitters operation under Section 1 5.247 are required to add ress RF exposure compliance in accord ance with Section 15.247(b)(4)	The RF e xposure con dition of this device is compliant with FCC ru les. Please refer to the MPE Calculation.

Sincerely,

Duk-su, Oh Chief research engineer

anuary 17, 2013